



PCB Layout Diagram
Top View

NOTE:

1. MATERIAL:

- a. HOUSING: THERMOPLASTIC GLASS FIBRE UL94V-0
- b. CONTACT: Mn Steel
- (SURFACE PLATING: Ni100u")

SEE ORDERING INFORMATION

2. ELECTRIC:

- a. CONTACT RESISTANCE: 30 MILLIOHMS MAX
- b. INSULATION RESISTANCE: 1000 MEGA OHMS MIN
- c. DIELECTRIC VOLTAGE: 500V AC ONE SEC LEVEL
- d. OPERATING TEMPERATURE: -25° C ~ +85° C

3	TERMINAL (-)	1	Mn Steel, T=0.45MM	Ni-Plating
2	TERMINAL (+)	1	Mn Steel, T=0.45MM	Ni-Plating
1	HOUSING	1	PBT	BLACK
NO	PAPT NAMF	0' TV	MATPP1AI	PI ATINC 2 COI OP

ECN NO.	REV.	DATE.	DESCRIPTION.	CHANGE.	CHECK.	APPRO.
	A		NEW			

APPROVALS		DATE	<p>深圳市联丰电子有限公司 SHENZHEN LINFENG ELECTRONIC CO.,LTD</p>	TITLE:	<p>电池座</p>	
DRAWN	ZHIWEI.CHEN	2015.07.07		PART NO.		GP07-CR2032-01
CHECKED				UNIT: mm		SCALE: 1:1
TOLERANCES ARE			30~以上 ±0.30	ANGLE	<p>PROJ: </p>	
			10~30 ±0.20	±2'		
			5~10 ±0.15	DRAWING NO.	<p>SHEET 1 OF 1</p>	
			~ 5 ±0.10			